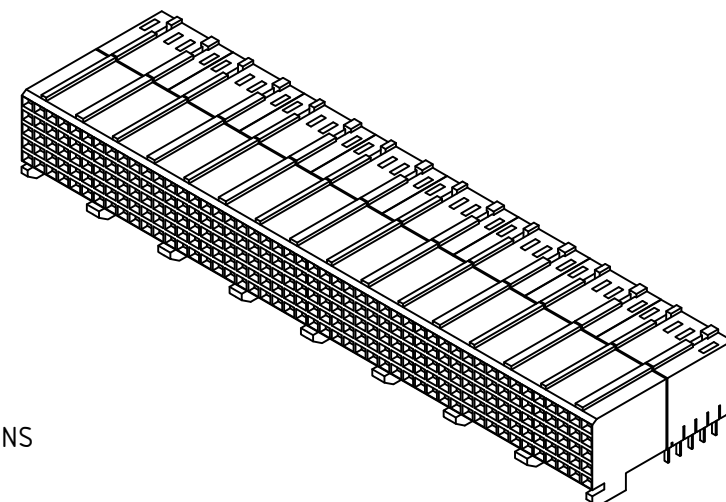
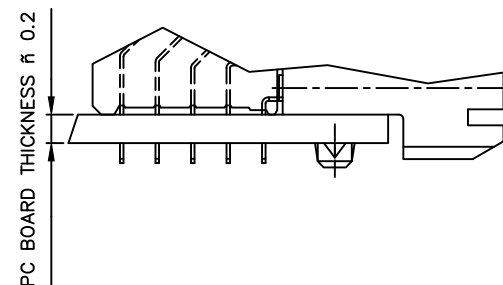
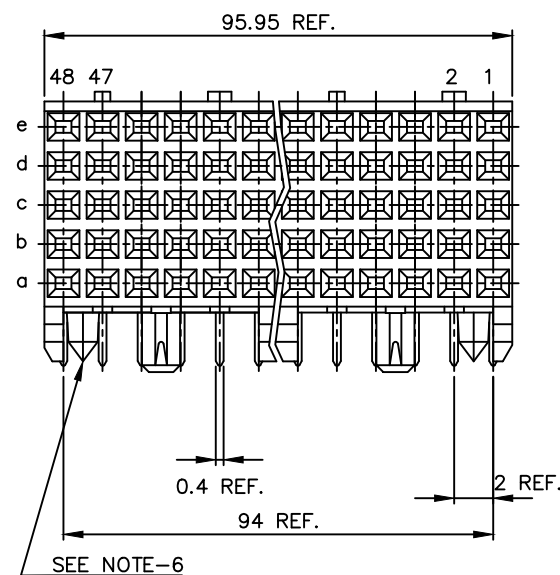
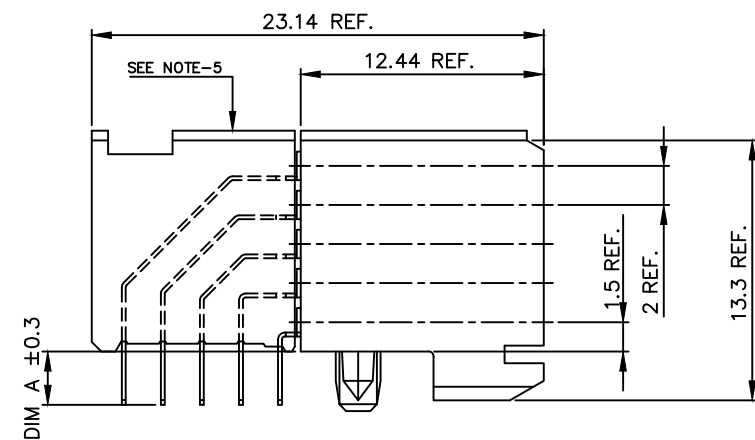
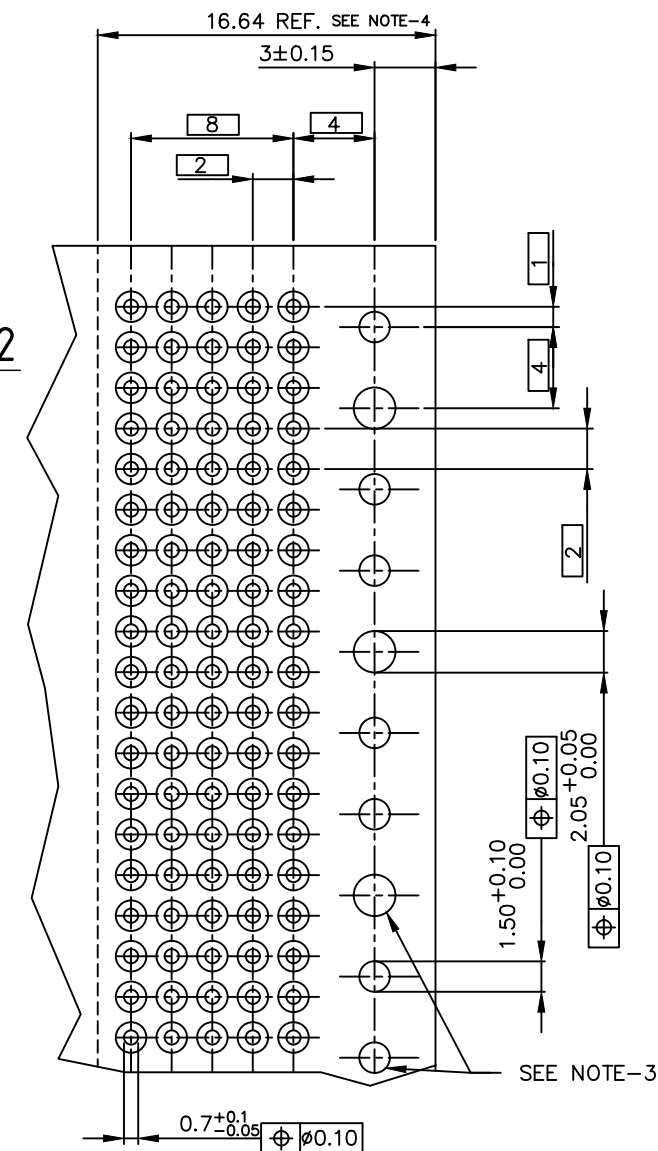


PC BOARD VERSIONS		
PRODUCT NR:	PCB THICKNESS	DIM A
85866-X02LF	1.6	2.90
85866-X12LF	2.4	3.53



REFER NOTE-2

85866-XY YLF



RECOMMENDED HOLE PATTERN,
COMPONENT SIDE.

NOTES:

- MATERIAL : BODY : LCP UL94-V0
: CONTACT : COPPER ALLOY.
- FOR PLATING PERFORMANCE REFER DRAWING # 10159408 
- INDICATED HOLES ARE UNPLATED.
- SET BACK FOR PRESS BLOCK.
- TOP SURFACE OF PRESS BLOCK MAY EXTEND UP TO 0.4MM HIGHER THAN HOUSING.
THIS MAY AFFECT THE TAIL LENGTH BEFORE APPLICATION TO A BOARD
- DIAMOND LOCATION PEG ARE ONLY EXISTED ON THE BOTH SIDES OF PRODUCT.
- THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS
AS DESCRIBED IN GS-47- 0004.
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260DEGREE PEAK TEMPERATURE FOR
10 SECONDS IN A WAVE SOLDER APPLICATION.
- A  SYMBOL WILL BE NEXT TO ANY DIMENSION, VIEW, OR NOTE WHICH HAS BEEN MODIFIED
WITH THE CURRENT DRAWING REVISION.

mat'l. code				NOTE 1		surface 58 ISO 1302		tolerance ISO 406 ISO 1101		projection 		product family METRAL											
ltr		ecn no		dr		date		tolerances unless otherwise specified						title									
G		DG08-0171		TER		2008-08-26		angles		linear		0.X±0.3				5 ROW R.A. S.T.B SIGNAL RECEPT.96mm MOD. P.P.							
H		DG09-0068		CENH		2009-03-03				0.XX±0.13													
J		ELX-I-38913		MINI		2020-10-23		0°±2°		0.XXX±0.050		scale 1:1											
								dr		R. VISSCHERS		1994-10-05				dwg no		sheet 1 of 1		size A3			
								enrg		ARUN		2020-10-23											
										chr		ALEX BABU										2020-10-23	
										appd		SANOJ										2020-10-23	
sheet index		revision sheet		J		1																	